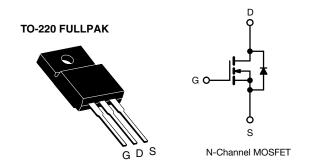


Vishay Siliconix

# **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	400	400			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	0.55			
Q <sub>g</sub> max. (nC)	66	;			
Q <sub>gs</sub> (nC)	10				
Q <sub>gd</sub> (nC)	33				
Configuration	Single				



#### **FEATURES**

- Isolated package
- High voltage isolation = 2.5 kV<sub>RMS</sub> (t = 60 s; f = 60 Hz



RoHS

- Sink to lead creepage distance = 4.8 mm
- Dynamic dV/dt rating
- · Low thermal resistance
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. The isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION		
Package	TO-220 FULLPAK	
Lead (Pb)-free	IRFI740GPbF	
	SiHFI740G-E3	
SnPb	IRFI740G	
	SiHFI740G	

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	400	V	
Gate-Source Voltage			$V_{GS}$	± 20		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	1	5.4	А	
		T <sub>C</sub> = 100 °C	ID	3.4		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	22		
Linear Derating Factor				0.32	W/°C	
Single Pulse Avalanche Energy b			E <sub>AS</sub>	390	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	5.4	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	4.0	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	$P_{D}$	40	W	
Peak Diode Recovery dV/dt c			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering Recommendations (Peak temperature) <sup>d</sup>	for 10 s		-	300	7	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b.  $V_{DD}=50$  V, starting  $T_J=25$  °C, L=23 mH,  $R_g=25$   $\Omega$ ,  $I_{AS}=5.4$  A (see fig. 12). c.  $I_{SD}\leq 10$  A,  $I_{AS}=10$  A,  $I_{AS}=10$

- d. 1.6 mm from case.



# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	3.1	G/ VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				•	I.	l	l
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.49	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zava Cata Valtaga Drain Current		V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V		-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 320 V	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3.2 A <sup>b</sup>	-	-	0.55	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> = 3.2 A <sup>b</sup>	3.6	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		-	1370	-	
Output Capacitance	C <sub>oss</sub>			-	380	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	f = 1.0 MHz, see fig. 5		140	-	
Drain to Sink Capacitance	С		f = 1.0 MHz	-	12	-	
Total Gate Charge	Qg	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 320 \text{ V},$ see fig. 6 and 13 b		-	-	66	
Gate-Source Charge	Q <sub>gs</sub>		-	-	10	nC	
Gate-Drain Charge	Q <sub>gd</sub>		see lig. 6 and 13		-		33
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD}$ = 200 V, $I_{D}$ = 10 A, $R_{g}$ = 9.1 $\Omega$ , $R_{D}$ = 20 $\Omega$ , see fig. 10 b		-	14	-	- ns
Rise Time	t <sub>r</sub>			-	25	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	54	-	
Fall Time	t <sub>f</sub>			-	24	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		0.2	-	1.3	Ω
Drain-Source Body Diode Characteristic	-	•					
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	5.4	А
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	22	A
Body Diode Voltage	V <sub>SD</sub>	$T_J = 25  ^{\circ}\text{C},  I_S = 5.4  \text{A},  V_{GS} = 0  \text{V}^{ \text{b}}$			-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 10 A, dl/dt = 100 A/μs b		-	330	730	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	2.8	6.6	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	n-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

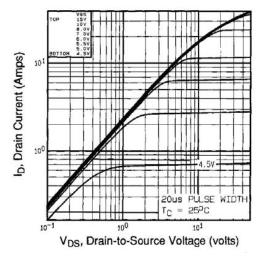


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

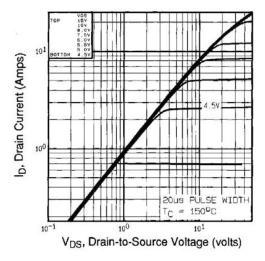


Fig. 2 - Typical Output Characteristics,  $T_C = 150$  °C

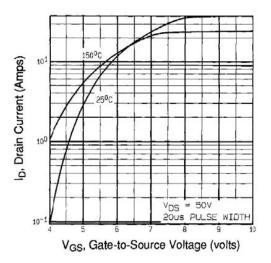


Fig. 3 - Typical Transfer Characteristics

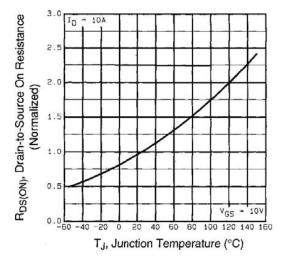


Fig. 4 - Normalized On-Resistance vs. Temperature



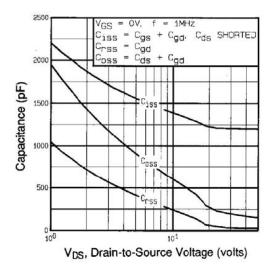


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

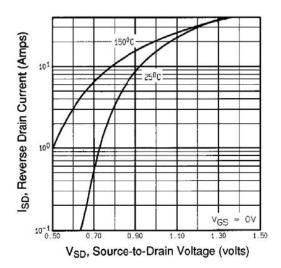


Fig. 7 - Typical Source-Drain Diode Forward Voltage

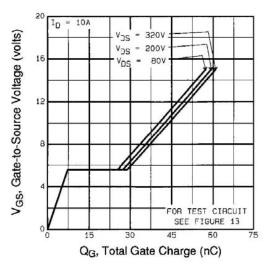


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

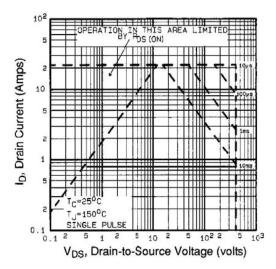


Fig. 8 - Maximum Safe Operating Area



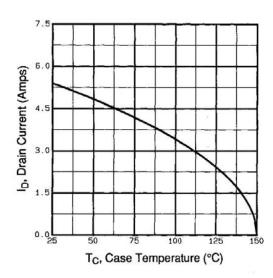


Fig. 9 - Maximum Drain Current vs. Case Temperature

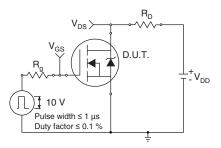


Fig. 10a - Switching Time Test Circuit

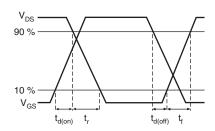


Fig. 10b - Switching Time Waveforms

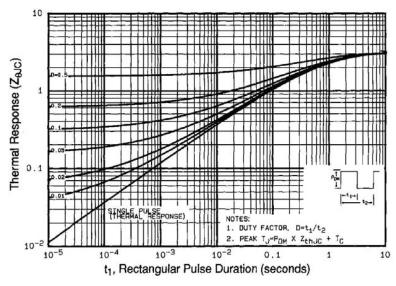


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

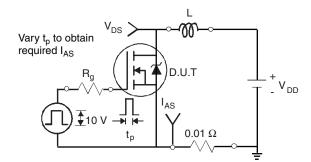


Fig. 12a - Unclamped Inductive Test Circuit

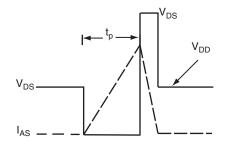


Fig. 12b - Unclamped Inductive Waveforms

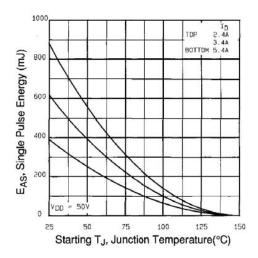


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

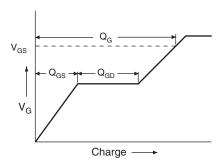


Fig. 13a - Basic Gate Charge Waveform

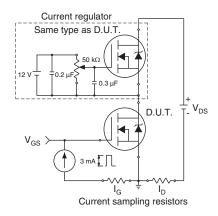
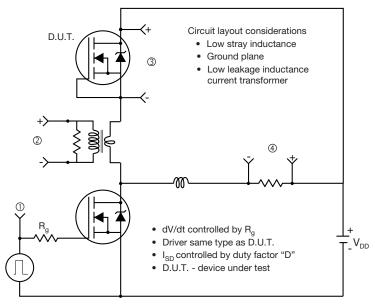


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



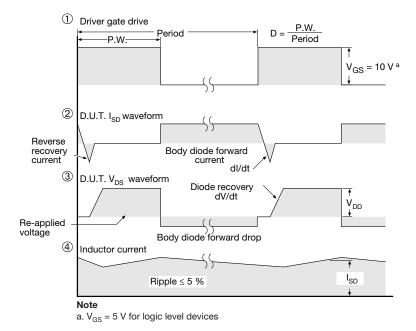


Fig. 14 - For N-Channel

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